

MOSFET – Power, Single N-Channel 40 V, 2.8 m Ω , 110 A

NVMFS5C450NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C450NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	40	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain		T _C = 25°C	I _D	110	Α
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		81	
Power Dissipation	State	T _C = 25°C	P _D	68	W
R _{θJC} (Note 1)		T _C = 100°C		34	
Continuous Drain		T _A = 25°C	I _D	27	Α
Current R _{0JA} (Notes 1, 2, 3)	Steady	T _A = 100°C	1	19	
Power Dissipation	State	T _A = 25°C	P_{D}	3.7	W
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.6	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	740	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to + 175	°C
Source Current (Body Diode)			I _S	76	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 7 A)			E _{AS}	215	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C	

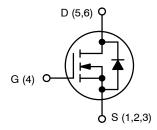
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.2	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	41	

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	2.8 m Ω @ 10 V	110 A
40 V	4.4 mΩ @ 4.5 V	TIOA

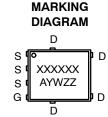


N-CHANNEL MOSFET



DFN5 & DFNW5 (SO-8FL) CASES 488AA & 507BE

W



XXXXXX = 5C450L

(NVMFS5C450NL) or

450LWF

(NVMFS5C450NLWF)

= Assembly Location= Year

= Work Week

ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

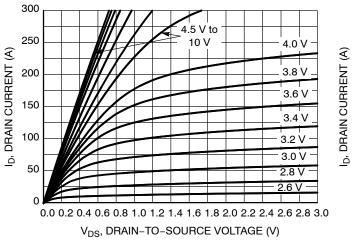
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS	•					•	•	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				1.6		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25°C			10		
		V _{DS} = 40 V	T _J = 125°C			250	μA 250	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{G}$	S = 20 V			100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 60 \mu A$		1.2		2.0	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.3		mV/°C	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 40 A		3.5	4.4	mΩ	
		V _{GS} = 10 V	I _D = 40 A		2.3	2.8	1	
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D = 40 A			120		S	
CHARGES, CAPACITANCES & GATE RE	SISTANCE				-			
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 20 V			2100			
Output Capacitance	C _{OSS}				1000		pF	
Reverse Transfer Capacitance	C _{RSS}				42			
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 20 V; I _D = 40 A			16		nC	
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 40 A			35		nC	
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 20 V; I _D = 40 A			4			
Gate-to-Source Charge	Q _{GS}				7		nC	
Gate-to-Drain Charge	Q_GD				5		1	
Plateau Voltage	V_{GP}				3.2		V	
SWITCHING CHARACTERISTICS (Note 5	5)	•			•		•	
Turn-On Delay Time	t _{d(ON)}				11			
Rise Time	t _r	Vos = 4.5 V. Vr	ne = 20 V.		110			
Turn-Off Delay Time	t _{d(OFF)}	V_{GS} = 4.5 V, V_{DS} = 20 V, I_{D} = 40 A, R_{G} = 1 Ω			21		ns	
Fall Time	t _f				5			
DRAIN-SOURCE DIODE CHARACTERIS	TICS					ı		
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V,	T _J = 25°C		0.84	1.2		
		I _S = 40 A		0.72		V		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, } dI_{s}/dt = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 40 \text{ A}$			41			
Charge Time	t _a				19		ns	
Discharge Time	t _b				22		1	
Reverse Recovery Charge	Q _{RR}				31		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

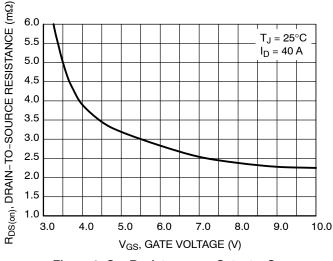
TYPICAL CHARACTERISTICS



300 V_{DS} = 5 V 250 V_{DS} = 5 V 150 150 T_J = 25°C T_J = -55°C V_{GS}, GATE-TO-SOURCE VOLTAGE (V)

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



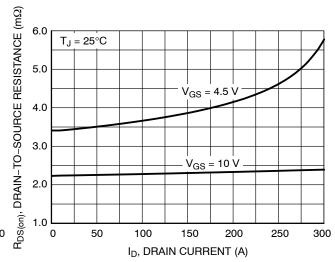
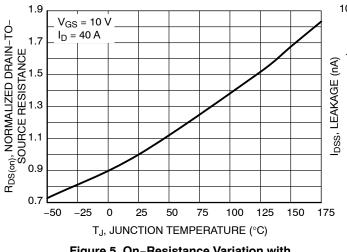


Figure 3. On-Resistance vs. Gate-to-Source Voltage

Figure 4. On-Resistance vs. Drain Current and Gate Voltage



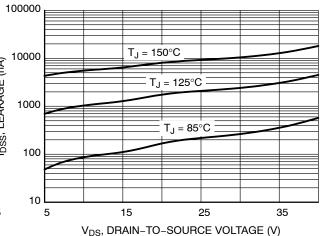
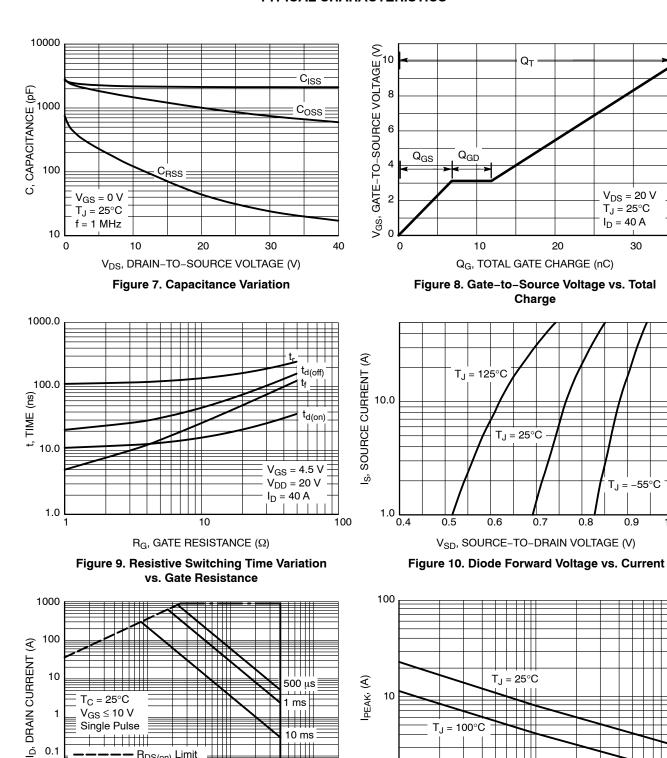


Figure 5. On–Resistance Variation with Temperature

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS



 $V_{DS}(V)$ Figure 11. Safe Operating Area

10

R_{DS(on)} Limit Thermal Limit Package Limit #

V_{GS} ≤ 10 V Single Pulse

TIME IN AVALANCHE (s) Figure 12. I_{PEAK} vs. Time in Avalanche

1E-3

 $T_J = 100^{\circ}C$

1 <u>–</u> 1E–4

1.0

10E-2

10 ms

100

0.01

0.1

TYPICAL CHARACTERISTICS

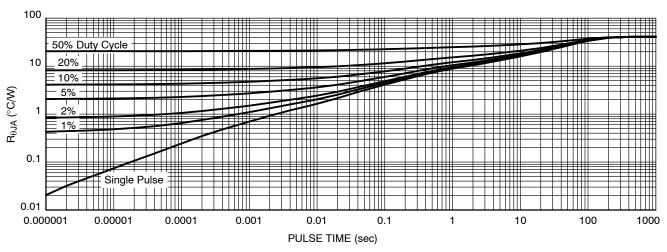


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5C450NLT1G	5C450L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C450NLWFT1G	450LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C450NLT3G	5C450L	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS5C450NLWFT3G	450LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C450NLAFT1G	5C450L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C450NLWFAFT1G	450LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C450NLWFET1G	450LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





0.10

0.10

SIDE VIEW

DFN5 5x6, 1.27P (SO-8FL) CASE 488AA **ISSUE N**

DATE 25 JUN 2018

NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION D1 AND E1 DO NOT INCLUDE
- MOLD FLASH PROTRUSIONS OR GATE BURRS

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.90	1.00	1.10	
A1	0.00	-	0.05	
b	0.33	0.41	0.51	
С	0.23	0.28	0.33	
D	5.00	5.15	5.30	
D1	4.70	4.90	5.10	
D2	3.80	4.00	4.20	
E	6.00	6.15	6.30	
E1	5.70	5.90	6.10	
E2	3.45	3.65	3.85	
е	1.27 BSC			
G	0.51	0.575	0.71	
K	1.20	1.35	1.50	
L	0.51	0.575	0.71	
L1	0.125 REF			
M	3.00	3.40	3.80	
θ	0 °		12 °	

GENERIC MARKING DIAGRAM*

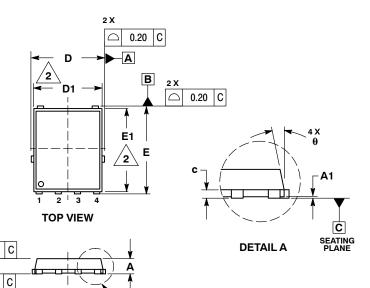


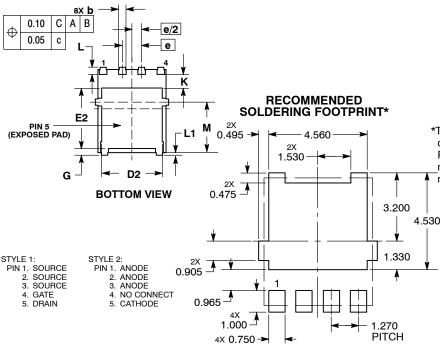
XXXXXX = Specific Device Code

= Assembly Location Α

Υ = Year W = Work Week = Lot Traceability ZZ

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.





DETAIL A

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DIMENSIONS: MILLIMETERS

DOCUMENT NUMBER:	98AON14036D	Electronic versions are uncontrolled except when accessed directly from the Document Repositor Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
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PIN 1

IDENTIFIER

DFNW5 4.90x5.90x1.00, 1.27P

CASE 507BE **ISSUE B**

DATE 19 SEP 2024

MAX

1.10

0.05

0.51

0.33

5.30

5.10

4.20

6.30

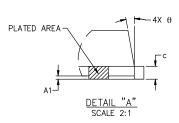
6.10

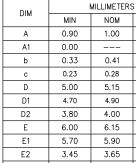
3.85

12°

NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M-2018.
- ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS
- THIS PACKAGE CONTAINS WETTABLE FLANK DESIGN FEATURES TO AID IN FILLET FORMATION ON THE LEADS DURING MOUNTING.







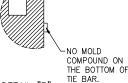
CONSTRUCTION

A



DETAIL "B"

SCALE 2:1

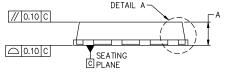


E3 3.40 3.80 3.00 1.27 BSC е 1.20 1.35 1.50 L 0.51 0.57 0.71 L2 0.15 REF.

6

0.

4.56



TOP VIEW

SIDE VIEW

0.10 C A B DETAIL B ф 0.05 C e/2 8X L

E2 PIN 5 (L2)

(EXPOSED PAD) -D2 BOTTOM VIEW **GENERIC**



-1.53-2X 0.48 PACKAGE 3.20 OUTLINE 1.33 2X 0.91-4X 1.00 0.97 1.27 PIN 1 ID PITCH 4X 0.75

θ

2X 0.50-

RECOMMENDED MOUNTING FOOTPRINT* *FOR ADDITIONAL INFORMATION ON OUR Pb—FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

= Assembly Location Α Υ = Year

W = Work Week 77 = Lot Traceability

XXXXXX = Specific Device Code *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION: DFNW5 4.90x5.90x1.00, 1.27P **PAGE 1 OF 1**

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